

Cost effective techniques for chip delayering and in-situ depackaging

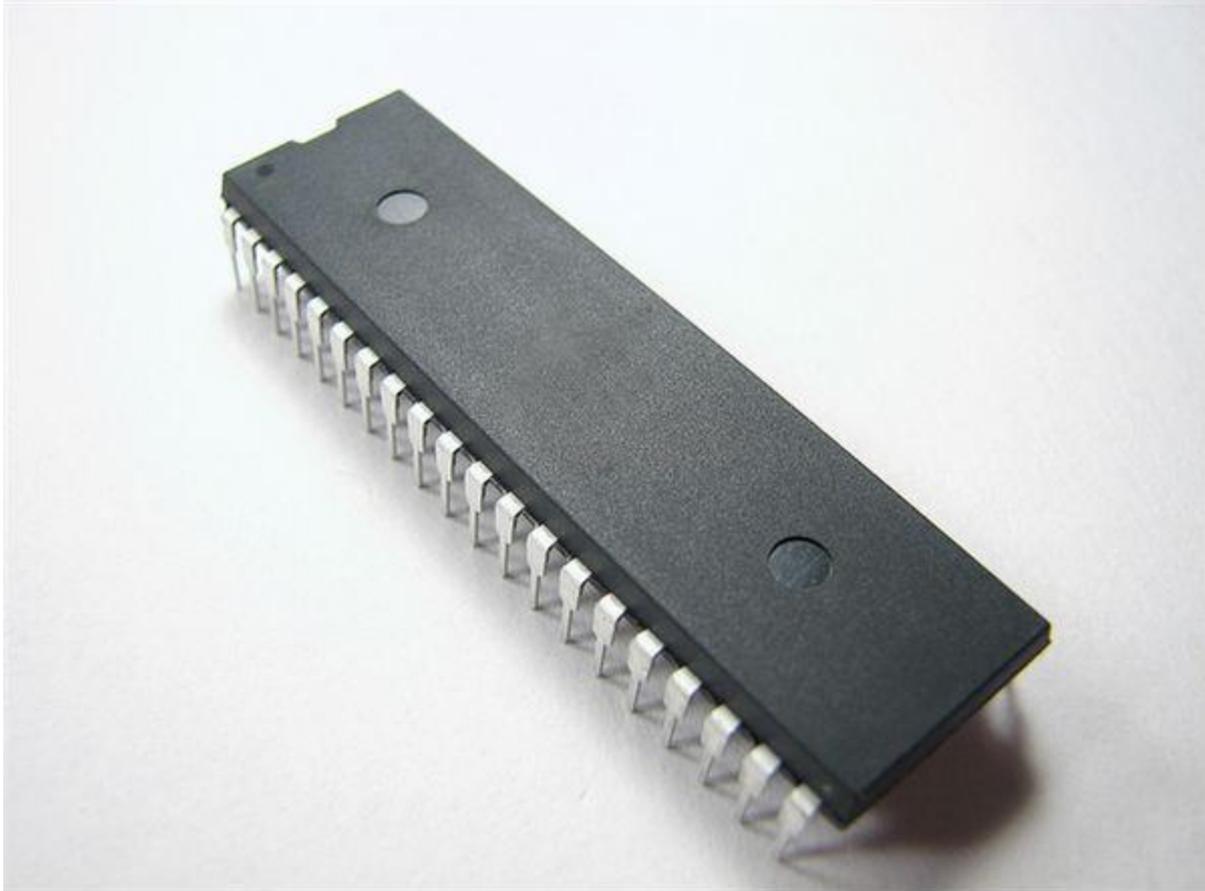
Philippe Loubet Moundi
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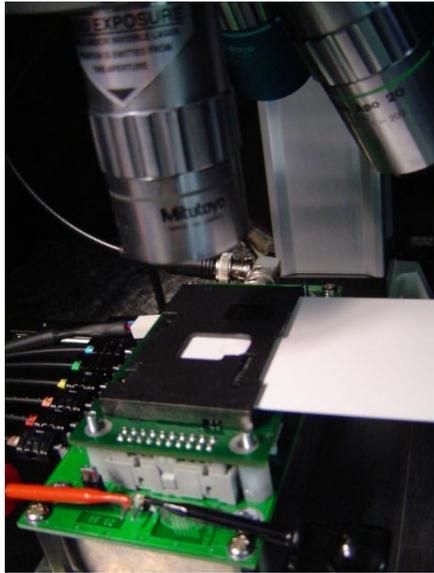
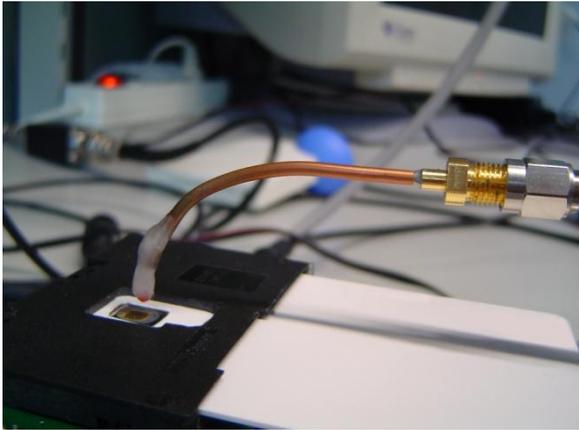
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COSADE 2013

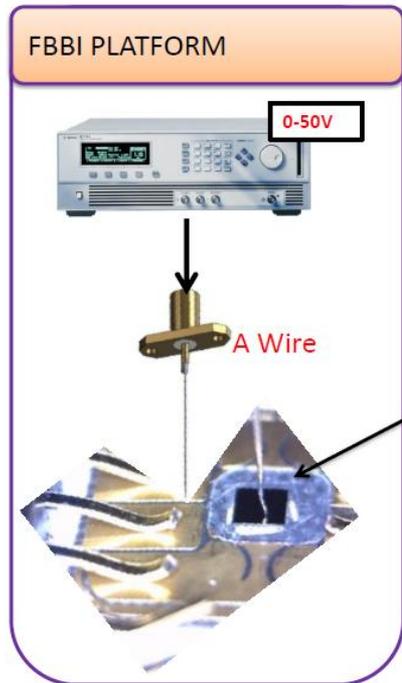
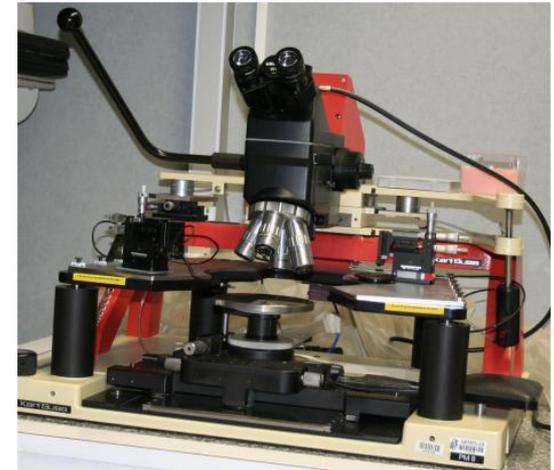
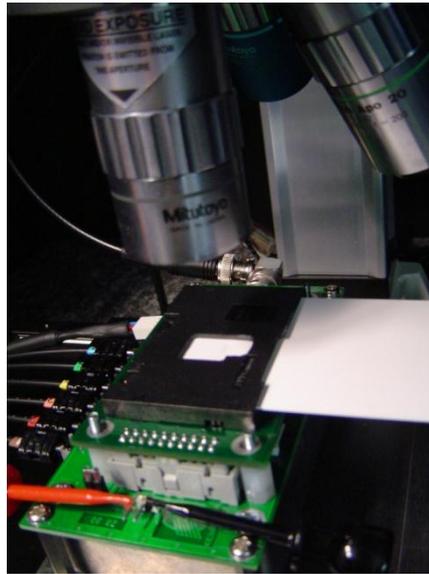
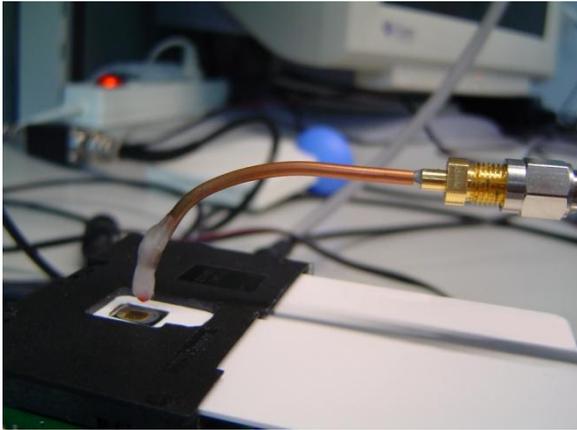
Part 1

IN-SITU DECAPSULATION









Courtesy of Ph. Maurine / LIRMM

Access to the die
Without compromising
die integrity
Without compromising
die bonding integrity



Access to the die Without removing the package from the system board



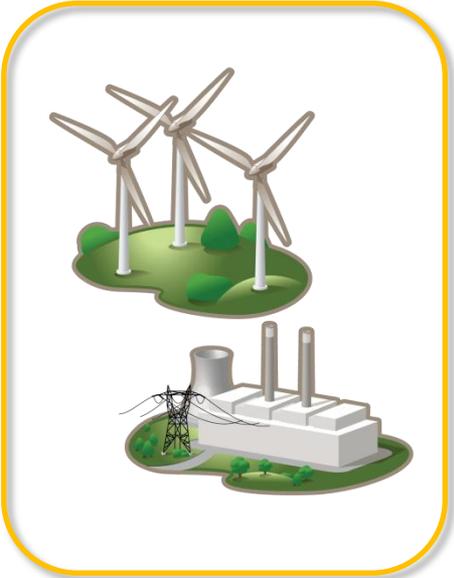


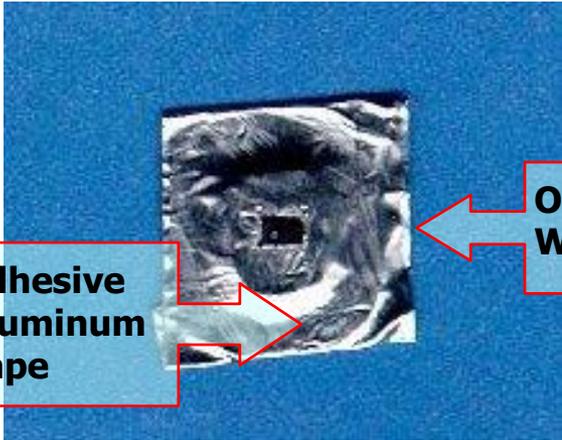






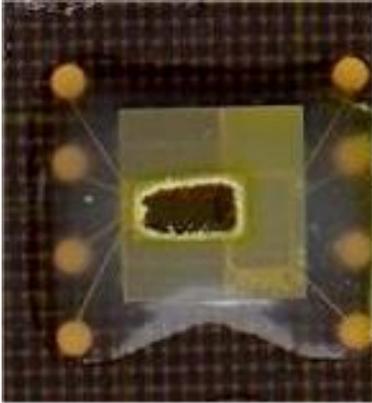
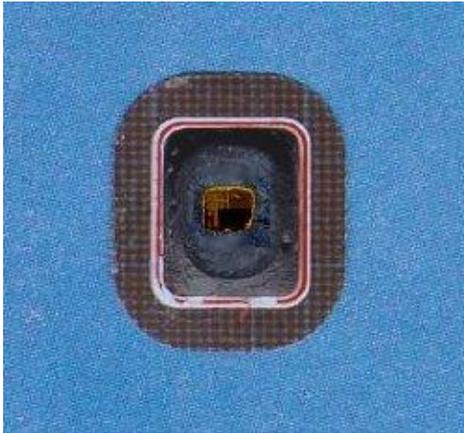






**Adhesive
Aluminum
Tape**

**Opening
Window**





In-situ depackaging summary

Pros

- ✘ Reliability
 - Single operation
 - No damage of the PCB
- ✘ Cost
 - Tools for de-soldering/soldering **not needed**
 - Bonding equipment **not needed**
 - Al adhesive tape
 - Hot Fuming Nitric Acid + Water (+ Acetone) + dry air (nitrogen)

Cons

- ✘ The side of the die exposed depends of the package
 - Lucky or unlucky?
 - 3D packages

Part 2

ULTRA LOW COST DELAYERING



Ultra low cost sample preparation

200K€



Ultra low cost sample preparation



Ultra low cost sample preparation

50K€



Ultra low cost sample preparation

50K€



Ultra low cost sample preparation

50K€



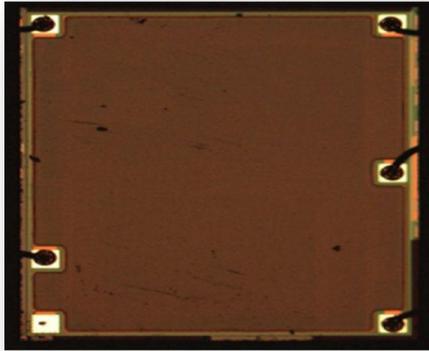
Ultra low cost sample preparation

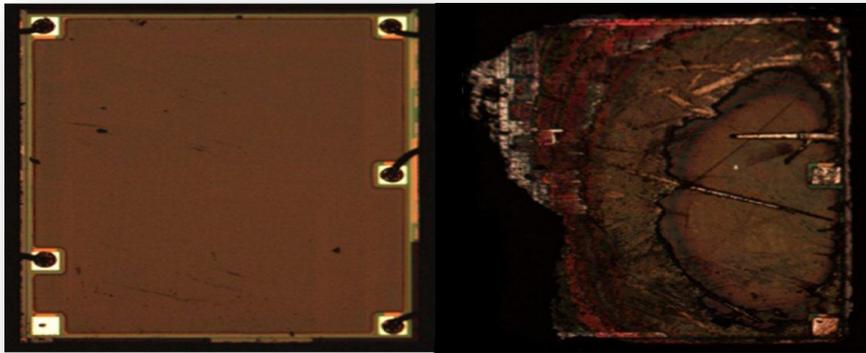
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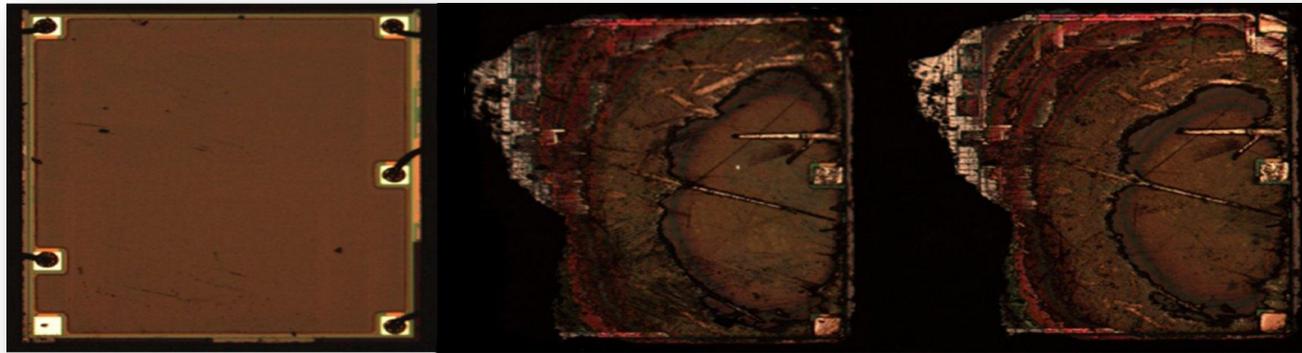


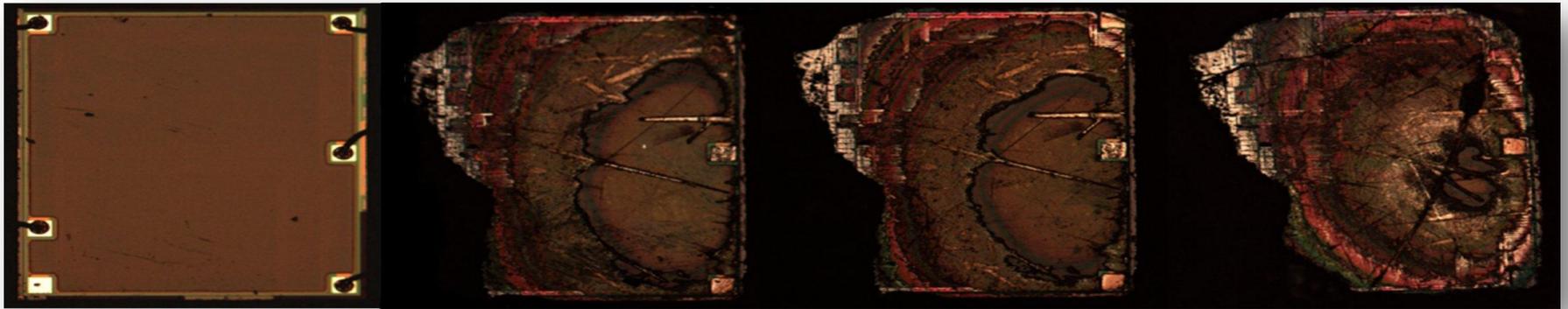
Ultra low cost sample preparation

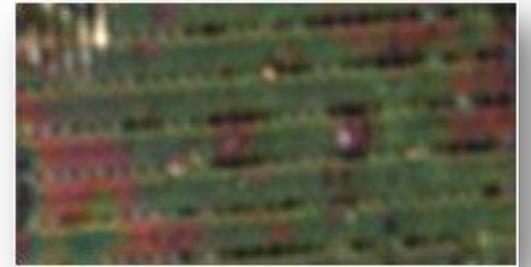
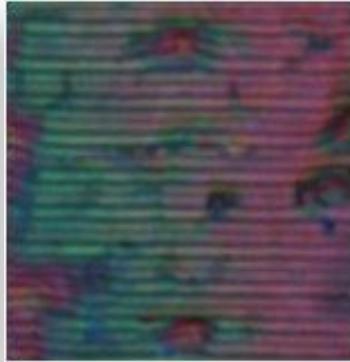


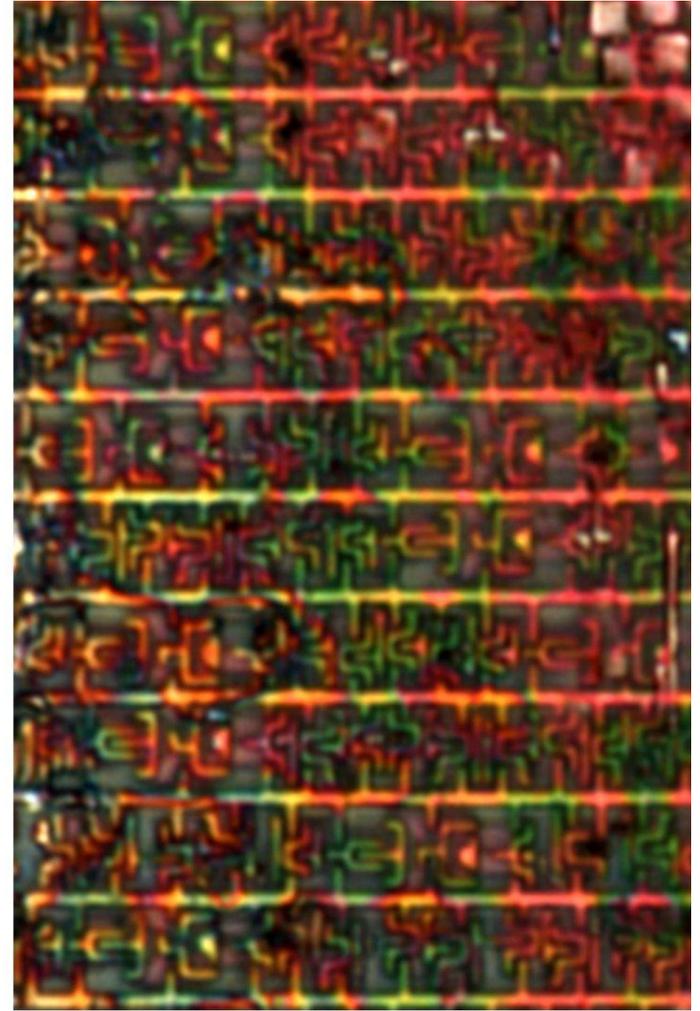
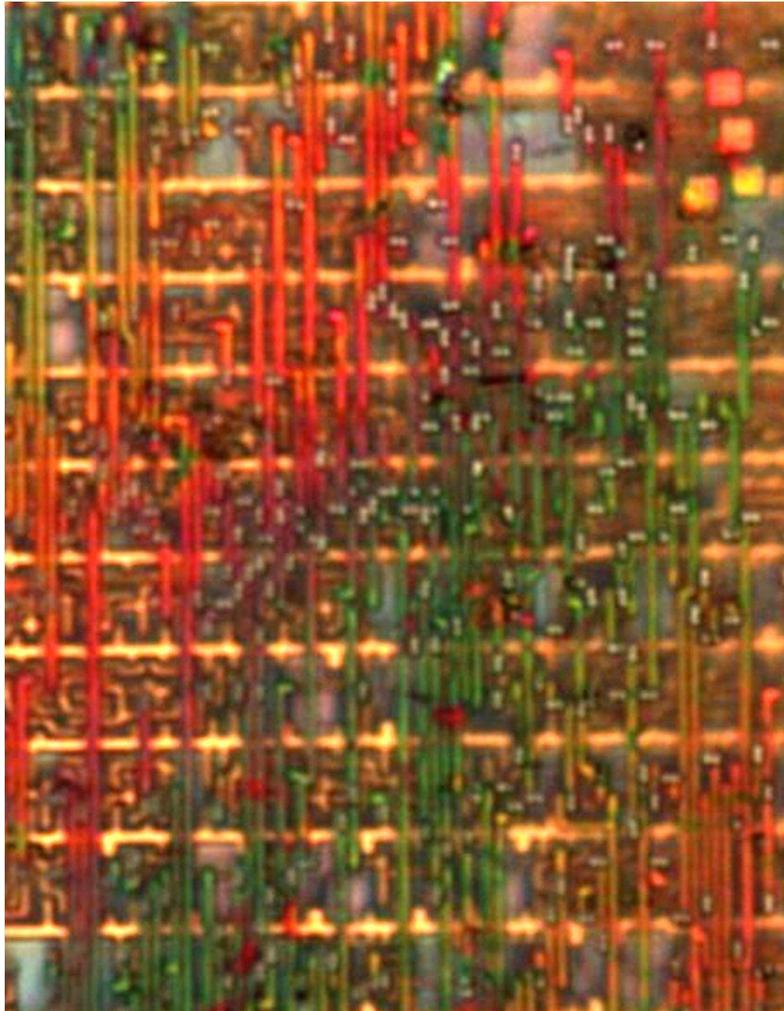


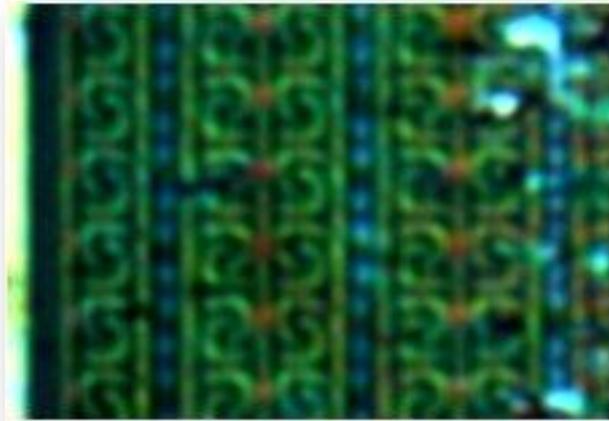




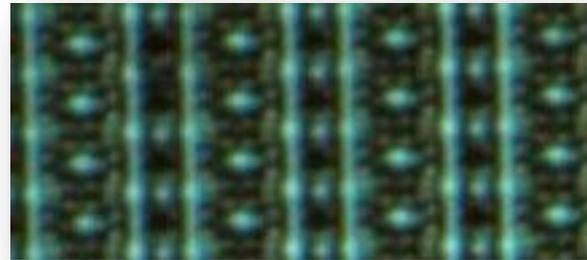


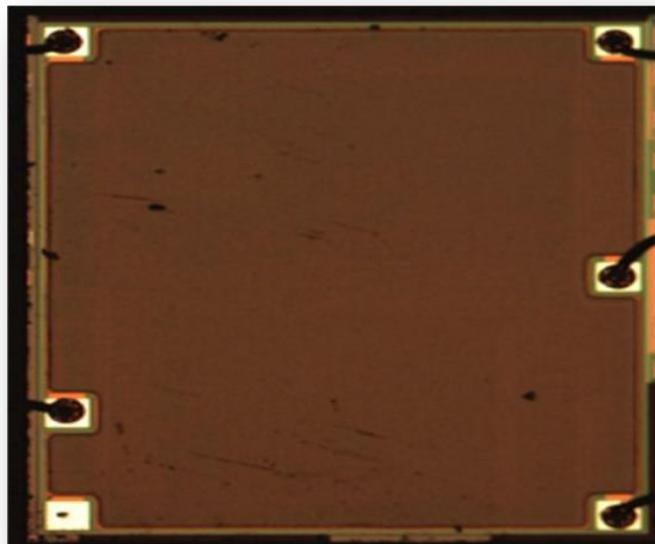


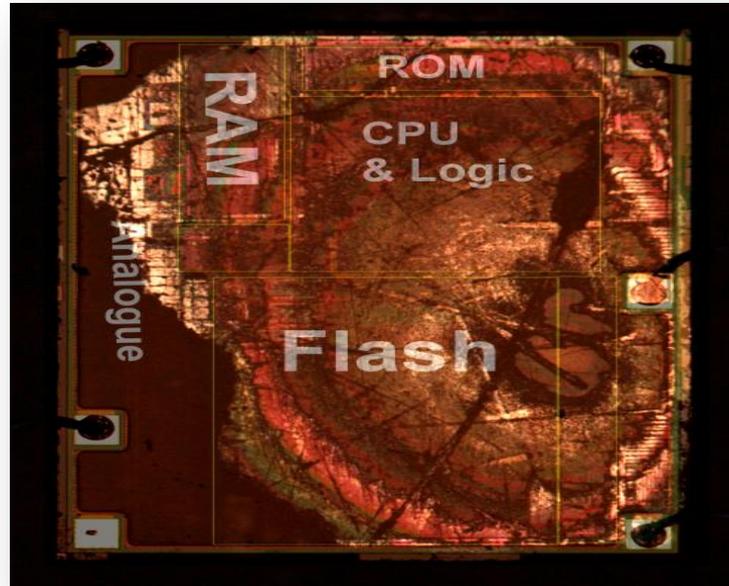












Ultra Low Cost Delaying (DJ, Die Jittering) Summary

- ✧ Of course, DJ sample preparation technique can be seen as a proof of concept
- ✧ But...
- ✧ It shows that very expensive equipments are not mandatory to get chip hidden data



CONCLUSION



Conclusion

- ✧ Cost effective techniques could (must?) be used for improving attacks
- ✧ Low cost in-situ depackaging gives significant advantages compare to chip extraction
- ✧ Ultra low cost sample preparation could gives very interesting information
- ✧ Having inside knowledge of the attacked chip is often the first step of a successful physical attack



Conclusion

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- ✦ Low cost in-situ depackaging gives significant advantages compare to chip extraction
- ✦ Ultra low cost sample preparation could gives very interesting information
- ✦ Having inside knowledge of the attacked chip is often the first step of a successful physical attack

So, try it !





They are ready to try
**THANK YOU FOR YOUR
ATTENTION**